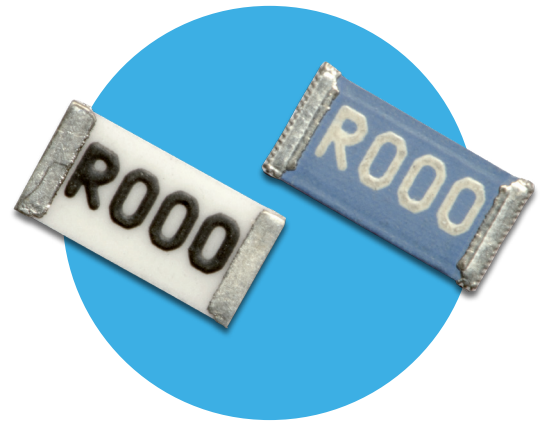


High Current Jumper Chip

LRZ Series

- High current zero-Ohm link
- Thick film copper technology
- Current rating to 35A
- Typical resistance 1.5mΩ
- Inductance below 0.2nH
- AEC-Q200 Qualified
- RoHS compliant and SnPb variants

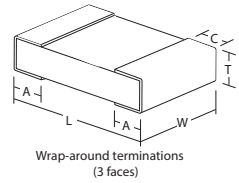


 All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

Size		0603	0805	1206	2010	2512	Notes
Current rating @ 70 °C	amps	6	15	20	30	35	DC or AC rms
2 second overload current @ 25°C	amps	12	30	40	60	70	
Residual resistance	ohms	0.003 max.					0.0015 typ.
Ambient temperature range	°C	-55 to +150					
Dielectric withstand voltage	volts	200					
Temperature rise at rated current	°C	15	30	40	80	90	
Pad & trace area for rated current	mm ²	40	40	50	100	300	See Application Notes

Physical Data

Dimensions (mm) & Weight (g)							
	L	W	T	A	C	Wt	
0603	1.6 ± 0.3	0.8 ± 0.2	0.5 ± 0.1	0.3 ± 0.15	0.25 ± 0.15	0.003	
0805	2.0 ± 0.3	1.25 ± 0.2	0.61 ± 0.1	0.3 ± 0.15		0.009	
1206	3.20 ± 0.31	1.63 ± 0.2	0.61 ± 0.1	0.48 ± 0.25	0.48 ± 0.25	0.020	
2010	5.23 ± 0.38	2.64 ± 0.25	0.74 ± 0.1	0.48 ± 0.25	0.48 ± 0.25	0.036	
2512	6.5 ± 0.38	3.25 ± 0.25	0.74 ± 0.1	0.48 ± 0.25	0.48 ± 0.25	0.055	

Construction

A thick film copper conductive element and organic protection are screen printed on a 96% alumina substrate. Pb-free parts supplied under USA part numbering have the conductive element on the underside, whilst all other parts have it on the upper side. These two formats are functionally identical and interchangeable, and marking is always on the upper surface.

Marking

The body protection is resistant to all normal cleaning solvents suitable for printed circuits. 0603 and 0805 size chips are unmarked. Pb-free 1206 size chips supplied under USA part numbering are marked LRZ. All other parts are marked R000.

Terminations

The wrap-around copper terminations have an electroplated nickel barrier and solderable coating, which ensures excellent 'leach' resistance properties and solderability. Chips can withstand immersion in solder at 260°C for 30 seconds and are suitable for reflow or wave soldering processes.

General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

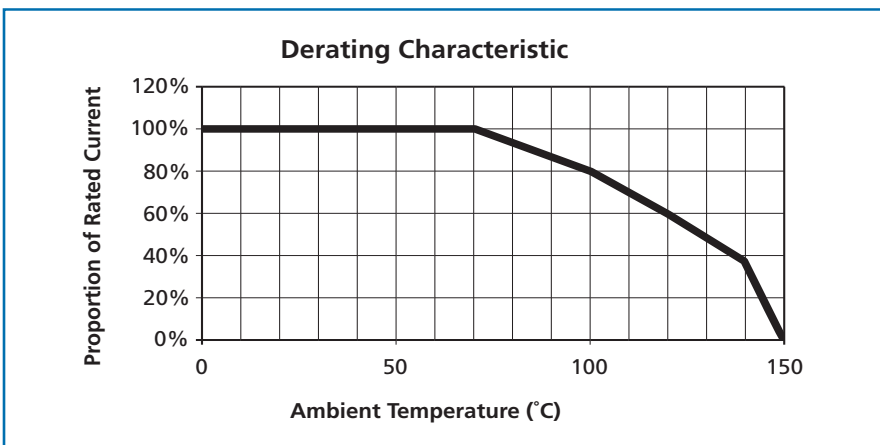
LRZ Series

AEC-Q200 Table 7		Method	Result
ref	Test		
3	High Temp. Exposure	MIL-STD-202 Method 108	Pass (see note 1)
4	Temperature Cycling	JESD22 Method JA-104	Pass (see note 1)
6	Moisture Resistance	MIL-STD-202 Method 106	Pass (see note 1)
7	Biased Humidity	MIL-STD-202 Method 103	Pass (see note 1)
8	Operational Life (Cyclic Load)	MIL-STD-202 Method 108	Pass (see note 1)
14	Vibration	MIL-STD-202 Method 204	Pass (see note 1)
15	Resistance to Soldering Heat	MIL-STD-202 Method 210	Pass (see note 1)
16	Thermal Shock	MIL-STD-202 Method 107	Pass (see note 1)
18	Solderability	J-STD-002	>95% coverage
21	Board Flex	AEC-Q200-005	Pass (see note 1)
22	Terminal Strength	AEC-Q200-006	Pass (see note 1)
	Leach Resistance	Solder dip at 250°C	90s minimum

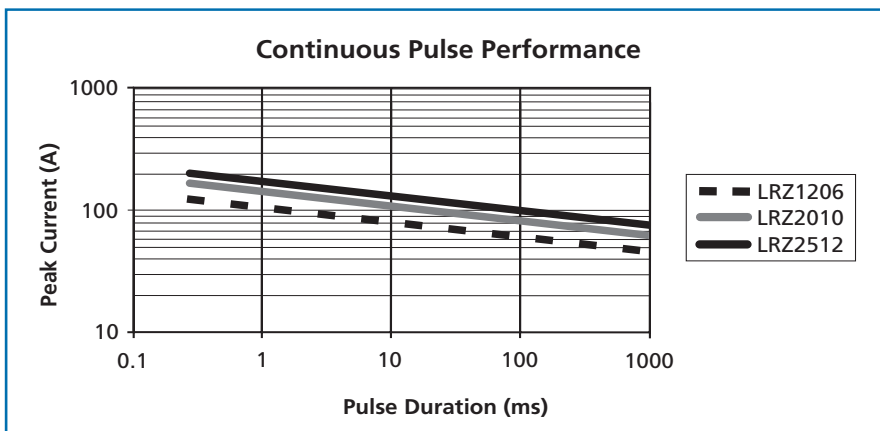
Notes:

1. AEC qualification based on testing of structurally similar LRF Series low value chip resistors, of which LRZ is the zero-ohm version. ΔR measurements are not applicable to the zero-ohm version.
2. Although 2010 and 2512 sizes have passed temperature cycling and thermal shock, it is in general not recommended that ceramic chips this large be used on FR4 in a severe temperature cycle environment due to the possibility of solder joint fatigue.
3. Full AEC-Q200 qualification applies to sizes 0603, 1206, 2010 and 2512

Temperature Derating



Pulse Performance



General Note

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LRZ Series

Application Notes

Conventional thick film “zero-Ohm” jumper chips typically have up to 50mΩ resistance values and 1 to 2A current ratings. LRZ jumper chips offer a solution for currents over an order of magnitude greater by combining lower resistance values with better thermal conductivity.

Care should be taken when designing the associated printed circuit board tracks to ensure that they can carry the required current without excessive heating, for example by using multiple layers thermally linked with many vias. Any temperature rise caused by power dissipated in the PCB tracks themselves should be allowed for when calculating the ambient temperature in order to determine whether power de-rating should be applied. The minimum recommended pad and trace areas close to the resistor stated under Electrical Data should be provided at each terminal.

Pad and trace area close to the resistor is defined as being the total copper area within two squares of the edge of the solder pad, plus the solder pad area.

For multi-layer PCB’s, this minimum area requirement should be met by surface layers rather than buried layers. The actual solder pad area follows the normal design rules for chip resistors.

LRZ jumper chips themselves can operate at a maximum temperature of 150°C (see performance above). For conventionally soldered jumper chips, the joint temperature should not exceed 110°C. This condition is met when the stated current levels at 70°C are used.

Ordering Procedure

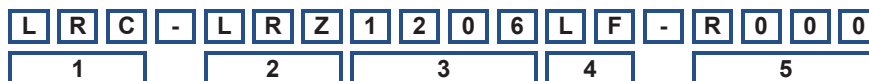
This product has two valid part numbers:

European (Welwyn) Part Number: LRZ1206-R000 (1206, Pb-free)



1	2	3	4	
Type	Size	Value	Termination & Packing	
LRZ	0603	R000	Omit for Pb-free, standard packing	
	0805		PB = SnPb finish, standard packing	
	1206		Standard packing is tape & reel	
	2010		0603	5000/reel
	2512		0805, 1206 & 2010	3000/reel
			2512	1800/reel

USA (IRC) Part Number: LRC-LRZ1206LF-R000 (1206, Pb-free)



1	2	3	4	5	Packing	
Family	Model	Size ¹	Termination	Value		
LRC	LRZ	1206	Omit for SnPb	R000	Standard packing is tape & reel	
		2010	LF = Pb-free		1206 & 2010	3000/reel
		2512			2512	1800/reel

Note 1: Sizes 0603 & 0805 are only available under European part numbering.

General Note

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[PF2512FKF7W0R033L](#) [CD2015FC-0.10-1%](#) [PR2512FKF7W0R004L](#) [RC1005F124CS](#) [RL73K3AR56JTDF](#) [RL7520WT-R001-F](#)
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[SR731ERTTP3R90F](#) [SR731ERTTP1R00F](#) [SR731ERTTP10R0F](#) [SR731ERTTP2R00F](#) [SR731ERTTP8R20F](#) [SR731ERTTP3R9J](#)
[SR731ERTTP8R2J](#) [SR731ERTTP2R0J](#) [SR731ERTTP4R7J](#) [SR731ERTTP9R1J](#) [SR731ERTTP1R0J](#) [SR731ERTTP2R2J](#)